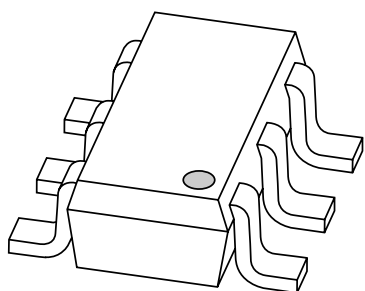


# DATA SHEET



**PMEM4010PD**

PNP transistor/Schottky diode  
module

Product specification

2002 Oct 28

PNP transistor/Schottky diode module

PMEM4010PD

FEATURES

- 600 mW total power dissipation
- High current capability
- Reduces required PCB area
- Reduced pick and place costs
- Small plastic SMD package.

Transistor:

- Low collector-emitter saturation voltage.

Diode:

- Ultra high-speed switching
- Very low forward voltage
- Guard ring protected.

APPLICATIONS

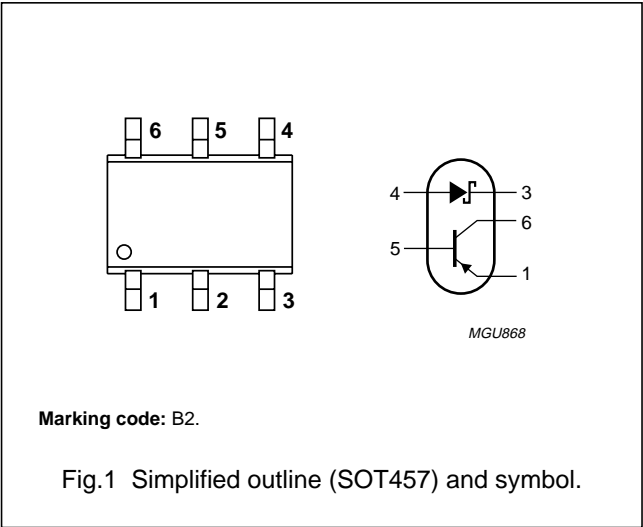
- DC/DC convertors
- Inductive load drivers
- General purpose load drivers
- Reverse polarity protection circuits.

DESCRIPTION

Combination of a PNP transistor with low  $V_{CEsat}$  and high current capability and a planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT457 (SC-74) small plastic package.  
NPN complement: PMEM4010ND.

PINNING

PIN	DESCRIPTION
1	emitter
2	not connected
3	cathode
4	anode
5	base
6	collector



## PNP transistor/Schottky diode module

## PMEM4010PD

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
<b>NPN transistor</b>					
$V_{CBO}$	collector-base voltage	open emitter	–	–40	V
$V_{CEO}$	collector-emitter voltage	open base	–	–40	V
$V_{EBO}$	emitter-base voltage	open collector	–	–5	V
$I_C$	collector current (DC)		–	–1	A
$I_{CM}$	peak collector current		–	–2	A
$I_{BM}$	peak base current		–	–1	A
$T_j$	junction temperature		–	150	°C
<b>Schottky barrier diode</b>					
$V_R$	continuous reverse voltage		–	20	V
$I_F$	continuous forward current		–	1	A
$I_{FSM}$	non repetitive peak forward current	$t = 8.3$ ms half sinewave; JEDEC method	–	5	A
$T_j$	junction temperature		–	125	°C
<b>Combined device</b>					
$P_{tot}$	total power dissipation	$T_{amb} \leq 25$ °C; note 1	–	600	mW
$T_{stg}$	storage temperature		–65	+150	°C
$T_{amb}$	operating ambient temperature		–65	+125	°C

**Note**

1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	in free air; note 1	208	K/W

**Note**

1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.

## PNP transistor/Schottky diode module

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## CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

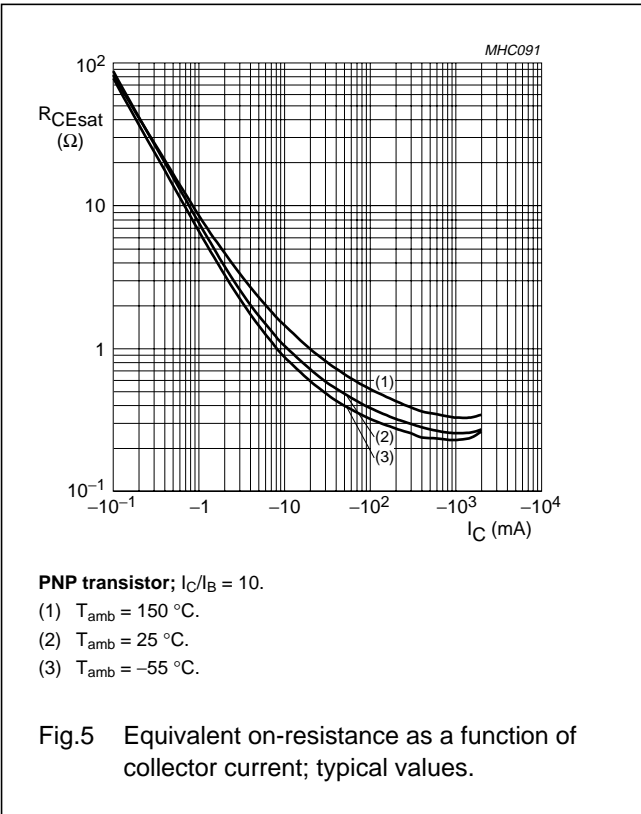
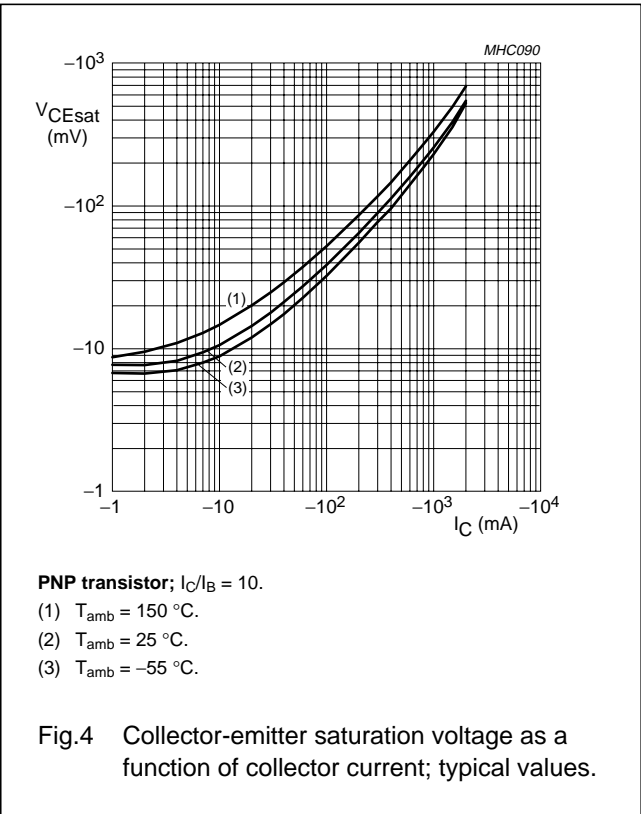
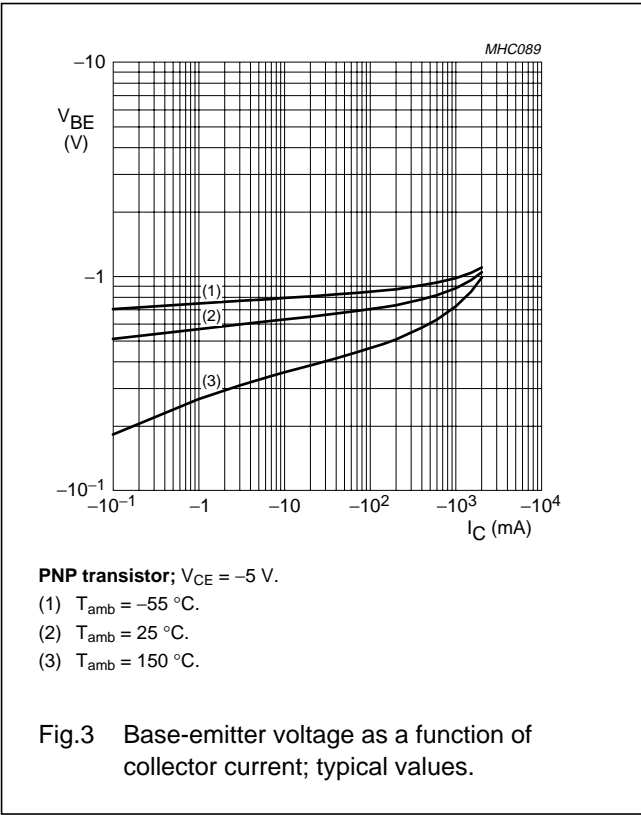
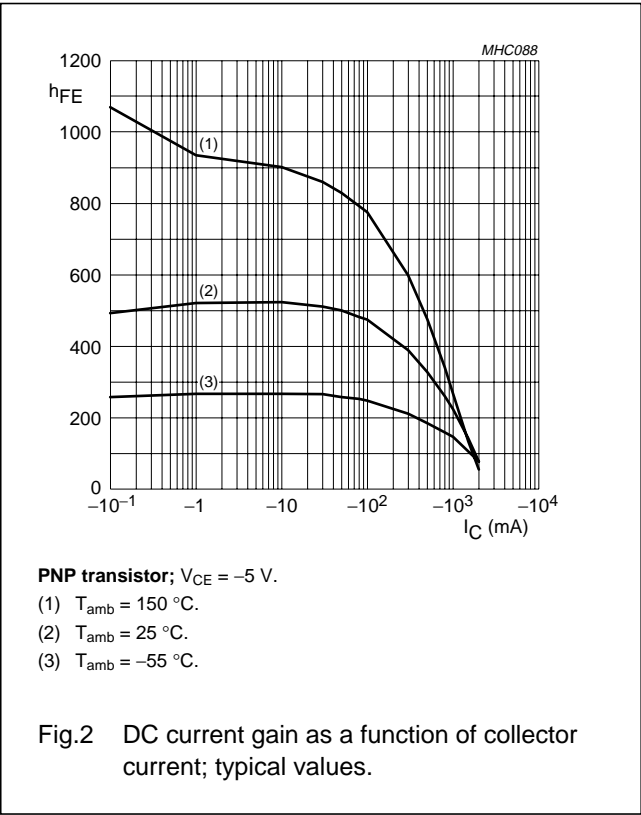
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>NPN transistor</b>						
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -40\text{ V}; I_E = 0$	–	–	–100	nA
		$V_{CB} = -40\text{ V}; I_E = 0;$ $T_{amb} = 150\text{ }^{\circ}\text{C}$	–	–	–50	$\mu\text{A}$
$I_{CEO}$	collector-emitter cut-off current	$V_{CE} = -30\text{ V}; I_B = 0$	–	–	–100	nA
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -5\text{ V}; I_C = 0$	–	–	–100	nA
$h_{FE}$	DC current gain	$V_{CE} = -5\text{ V}; I_C = -1\text{ mA}$	300	–	–	
		$V_{CE} = -5\text{ V}; I_C = -100\text{ mA}$	300	–	800	
		$V_{CE} = -5\text{ V}; I_C = -500\text{ mA}$	250	–	–	
		$V_{CE} = -5\text{ V}; I_C = -1\text{ A}$	160	–	–	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -100\text{ mA}; I_B = -1\text{ mA}$	–	–	–140	mV
		$I_C = -500\text{ mA}; I_B = -50\text{ mA}$	–	–	–170	mV
		$I_C = -1\text{ A}; I_B = -100\text{ mA}$	–	–	–310	mV
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -1\text{ A}; I_B = -50\text{ mA}$	–	–	–1.1	V
$R_{CEsat}$	equivalent on-resistance	$I_C = -500\text{ mA}; I_B = -50\text{ mA};$ note 1	–	300	<340	$\text{m}\Omega$
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = -5\text{ V}; I_C = -1\text{ A}$	–	–	–1	V
$f_T$	transition frequency	$I_C = -50\text{ mA}; V_{CE} = -10\text{ V};$ $f = 100\text{ MHz}$	150	–	–	MHz
<b>Schottky barrier diode</b>						
$V_F$	continuous forward voltage	$I_F = 10\text{ mA};$ note 1	–	240	270	mV
		$I_F = 100\text{ mA};$ note 1	–	300	350	mV
		$I_F = 1000\text{ mA};$ see Fig.7; note 1	–	480	550	mV
$I_R$	reverse current	$V_R = 5\text{ V};$ note 1	–	5	10	$\mu\text{A}$
		$V_R = 8\text{ V};$ note 1	–	7	20	$\mu\text{A}$
		$V_R = 15\text{ V};$ see Fig.8; note 1	–	10	50	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 5\text{ V}; f = 1\text{ MHz};$ see Fig.9	–	19	25	pF

## Note

1. Pulse test:  $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02$ .

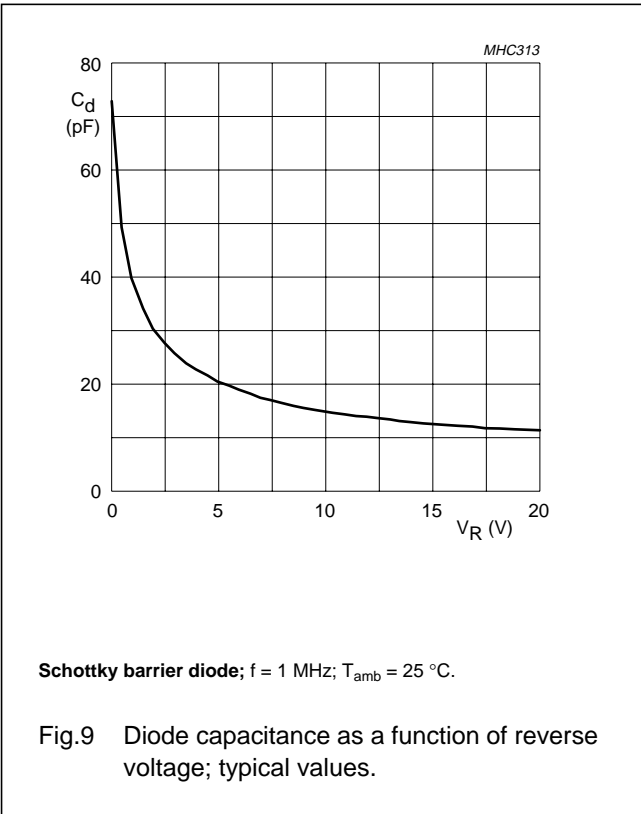
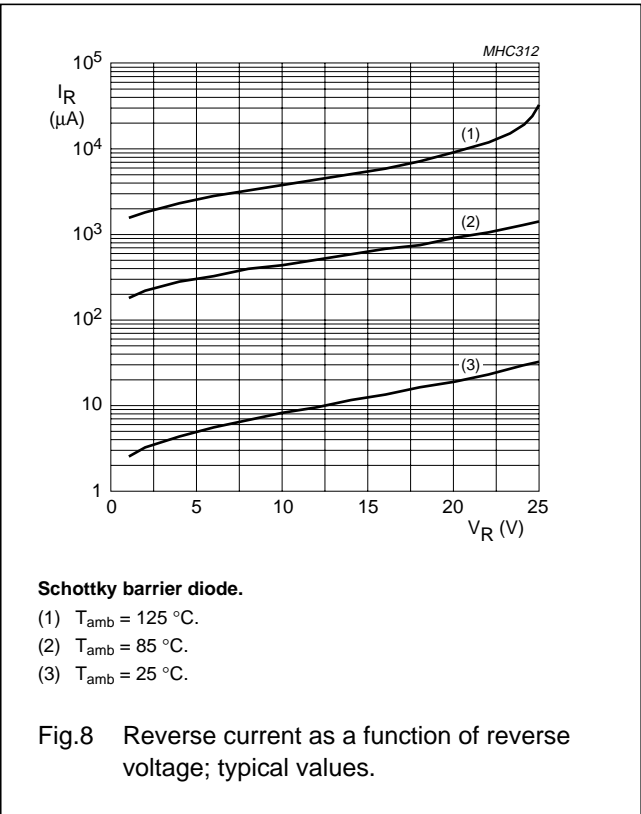
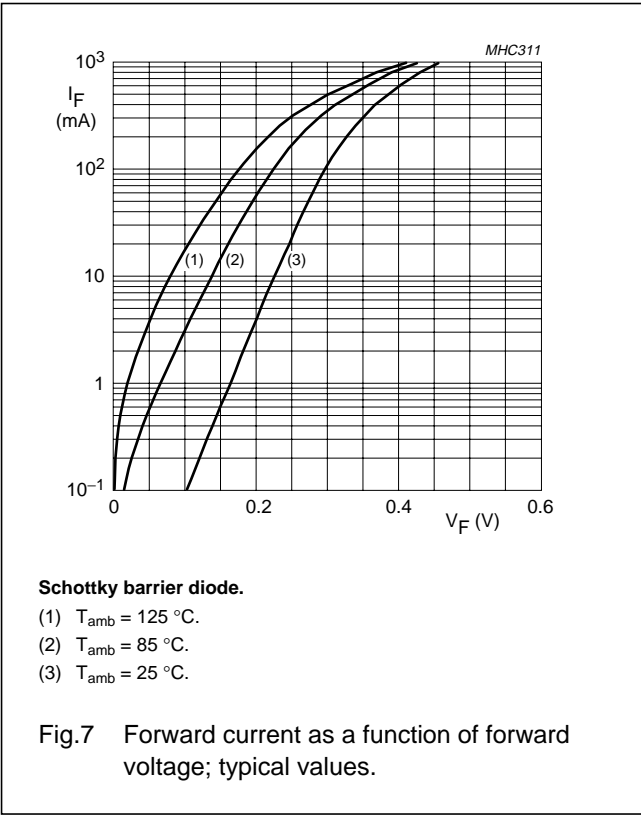
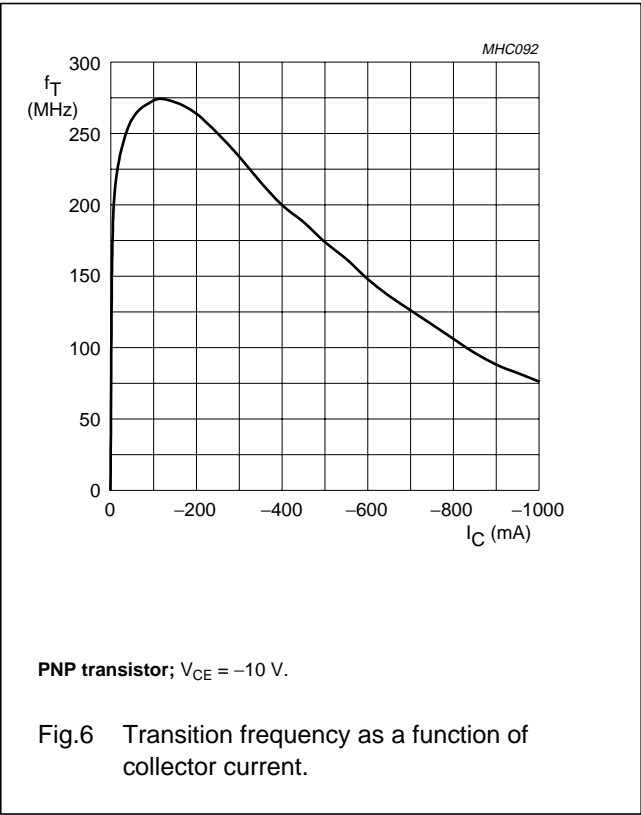
PNP transistor/Schottky diode module

PMEM4010PD



PNP transistor/Schottky diode module

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## PNP transistor/Schottky diode module

## PMEM4010PD

## APPLICATION INFORMATION

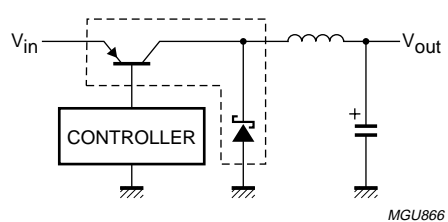


Fig.10 DC/DC convertor.

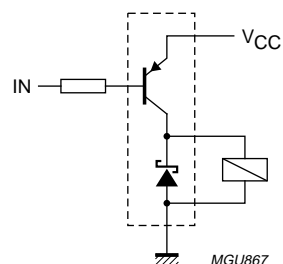


Fig.11 Inductive load driver (relays, motors, buzzers) with free-wheeling diode.

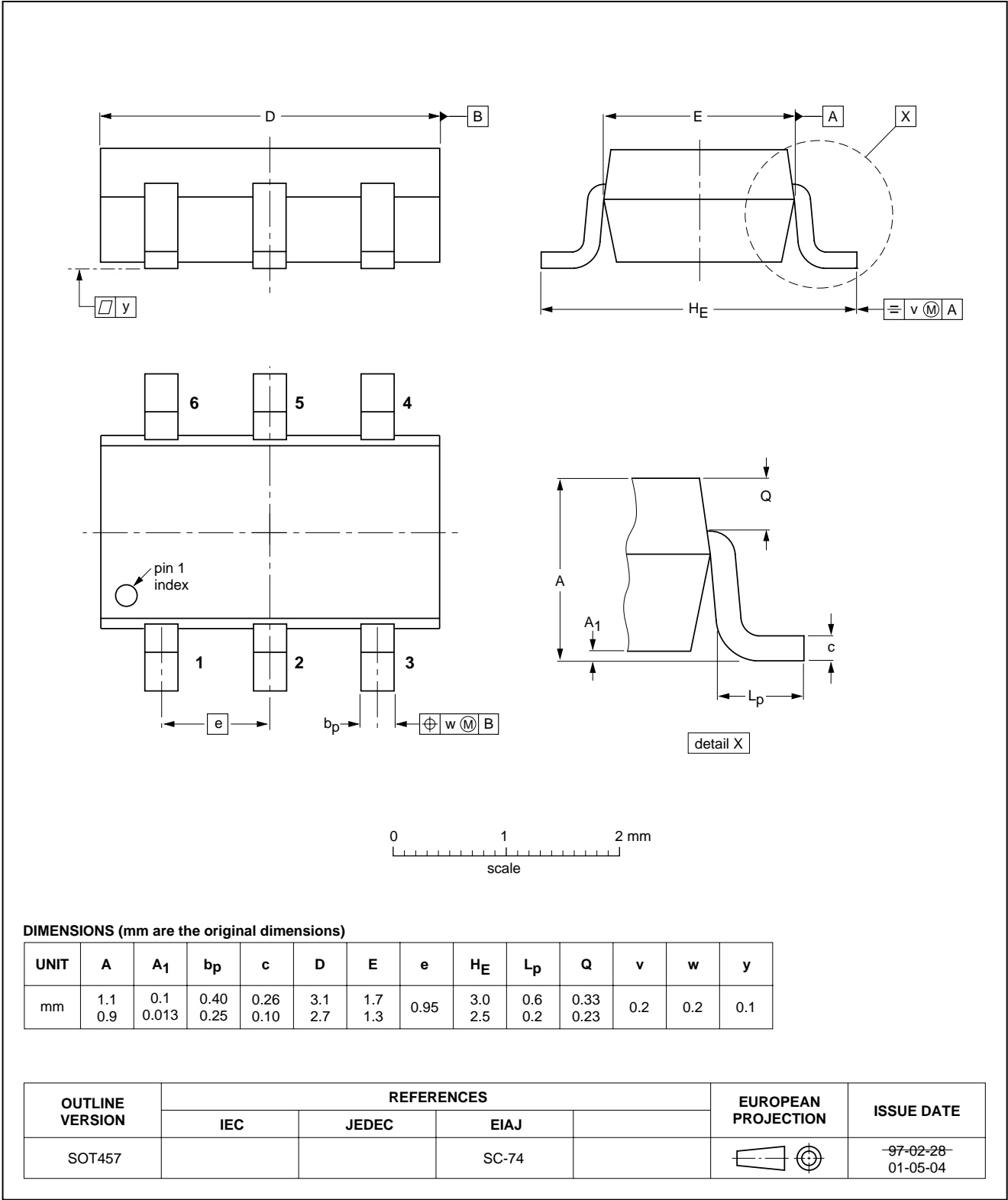
PNP transistor/Schottky diode module

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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT457





## PNP transistor/Schottky diode module

## PMEM4010PD

## DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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PNP transistor/Schottky diode module

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**NOTES**

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**NOTES**

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## **Contact information**

For additional information please visit **<http://www.semiconductors.philips.com>**. Fax: **+31 40 27 24825**

For sales offices addresses send e-mail to: **[sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com)**.

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